

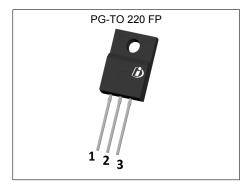
MOSFET

700V CoolMOS™ P7 Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

The latest CoolMOS™ P7 is an optimized platform tailored to target cost sensitive applications in consumer markets such as charger, adapter, lighting, TV, etc.

The new series provides all the benefits of a fast switching Superjunction MOSFET, combined with an excellent price/performance ratio and state of the art ease-of-use level. The technology meets highest efficiency standards and supports high power density, enabling customers going towards very slim designs.



Features

- Extremely low losses due to very low FOM R_{DS(on)}*Q_q and R_{DS(on)}*E_{oss}
- Excellent thermal behavior
- Integrated ESD protection diode
- Low switching losses (E_{oss})
- Product validation acc. JEDEC Standard

Benefits

- · Cost competitive technology
- Lower temperature
- High ESD ruggedness
- Enables efficiency gains at higher switching frequencies
- Enables high power density designs and small form factors

Potential applications

Recommended for Flyback topologies for example used in Chargers, Adapters, Lighting Applications, etc.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or seperate totem poles is generally recommended.



rable i Rey i crioimance i arameters						
Parameter	Value	Unit				
V _{DS} @ T _{j=25°C}	700	V				
R _{DS(on),max}	0.36	Ω				
$Q_{g,typ}$	16.4	nC				
I _{D,pulse}	34	A				
E _{oss} @ 400V	1.8	μJ				
$V_{(GS)th,typ}$	3	V				
ESD class (HBM)	2					

Type / Ordering Code	Package	Marking	Related Links
IPAN70R360P7S	PG-TO 220 FullPAK - Narrow Lead	70S360P7	see Appendix A

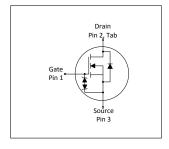










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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Oh a l		Value	s	Unit	
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	12.5 7.5	А	T _C = 20°C T _C = 100°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	34.0	Α	T _C =25°C
Application (Flyback) relevant avalanche current, single pulse ³⁾	I _{AS}	-	-	4.5	А	measured with standard leakage inductance of transformer of 10μH
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	V _{DS} =0400V
Gate source voltage	V _{GS}	-16 -30	-	16 30	V	static; AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	26.5	W	T _C =25°C
Operating and storage temperature	T _j , T _{stg}	-40	-	150	°C	-
Continuous diode forward current	I _S	-	-	5.7	Α	T _C =25°C
Diode pulse current ²⁾	I _{S,pulse}	-	-	34.0	Α	T _C = 25°C
Reverse diode dv/dt ⁴⁾	dv/dt	-	-	1	V/ns	V _{DS} =0400V, I _{SD} <=I _S , T _j =25°C
Maximum diode commutation speed ⁴⁾	di _f /dt	-	-	50	A/μs	$V_{DS} = 0400 \text{V}, I_{SD} <= I_S, T_j = 25^{\circ}\text{C}$
Insulation withstand voltage	V _{ISO}	-	-	2500	V	V _{rms} , T _C =25°C, t=1min

2 Thermal characteristics

Table 3 **Thermal characteristics**

Doromotor	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition
Thermal resistance, junction	R _{thJC}	-	-	4.7	°C/W	-
Thermal resistance, junction - ambient		-	-	80	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	_	-	260	°C	1.6 mm (0.063 in.) from case for 10s

 $^{^{1)}}$ DPAK / IPAK equivalent. Limited by $T_{j\,\text{max}}.$ T_{j} = 20°C. Maximum duty cycle D=0.5 $^{2)}$ Pulse width t_{p} limited by $T_{j,\text{max}}$ $^{3)}$ Proven during verification test. For explanation please read AN - CoolMOS $^{\text{TM}}$ 700V P7. $^{4)}$ V_{DClink} =400V; $V_{\text{DS,peak}}$
 $< V_{\text{(BR),DSS}}$; identical low side and high side switch with identical R_{G}



3 Electrical characteristics

Table 4 Static characteristics

Danier Mari	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	700	-	-	V	V _{GS} =0V, I _D =1mA
Gate threshold voltage	V _{(GS)th}	2.50	3	3.50	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 0.15 {\rm mA}$
Zero gate voltage drain current	I _{DSS}	-	- 10	1	μΑ	V _{DS} =700V, V _{GS} =0V, T _j =25°C V _{DS} =700V, V _{GS} =0V, T _j =150°C
Gate-source leakage current incl. Zener diode	I_{GSS}	-	-	1	μΑ	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.30 0.67	0.36	Ω	V _{GS} =10V, I _D =3.0A, T _j =25°C V _{GS} =10V, I _D =3.0A, T _j =150°C
Gate resistance	R _G	-	30	-	Ω	f=1 MHz, open drain

Table 5 Dynamic characteristics

Danamatan	Or made at		Value	s	Unit	N
Parameter	Symbol	Min.	Тур.	Typ. Max.		Note / Test Condition
Input capacitance	C _{iss}	-	517	-	pF	V _{GS} =0V, V _{DS} =400V, <i>f</i> =250kHz
Output capacitance	Coss	-	11	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	27	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	329	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V
Turn-on delay time	t _{d(on)}	-	19	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.3A, $R_{\rm G}$ =5.3 Ω
Rise time	t _r	-	8	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.3A, $R_{\rm G}$ =5.3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	100	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.3A, $R_{\rm G}$ =5.3 Ω
Fall time	t _f	-	18	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.3A, $R_{\rm G}$ =5.3 Ω

Table 6 Gate charge characteristics

Parameter	Cumbal	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition
Gate to source charge	Q_{gs}	-	2.3	-	nC	V_{DD} =400V, I_{D} =2.3A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	6.0	-	nC	V_{DD} =400V, I_{D} =2.3A, V_{GS} =0 to 10V
Gate charge total	Qg	-	16.4	-	nC	V_{DD} =400V, I_{D} =2.3A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	4.4	-	V	V_{DD} =400V, I_{D} =2.3A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

700V CoolMOS™ P7 Power Transistor



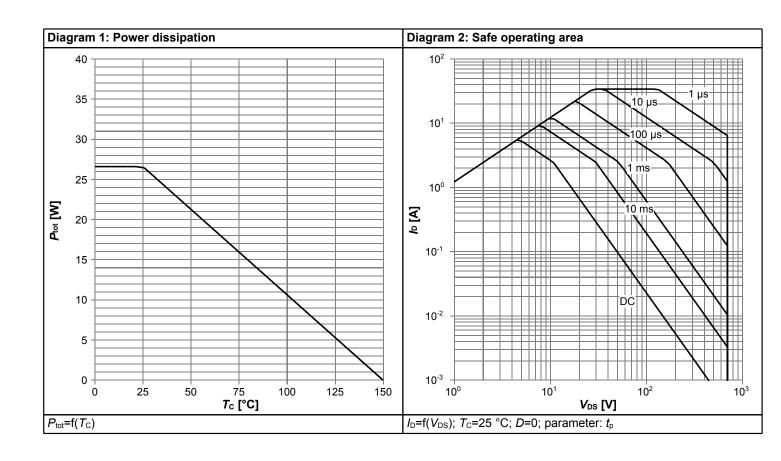


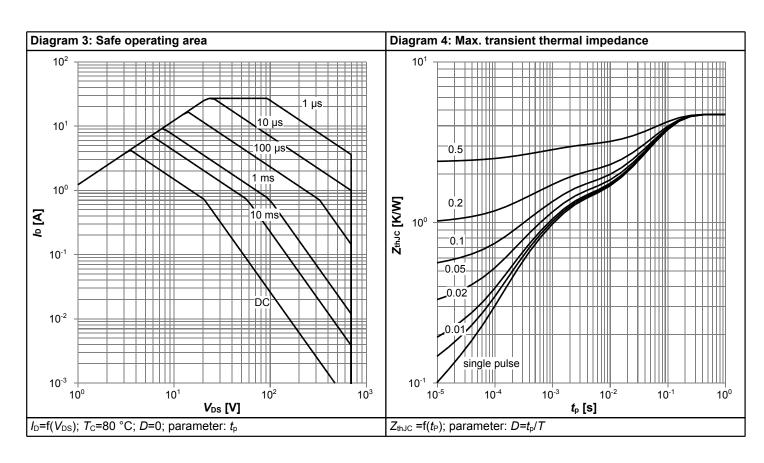
Table 7 Reverse diode characteristics

Davamatan	Cumbal	Values			11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V_{GS} =0V, I_F =3.8A, T_j =25°C
Reverse recovery time	t _{rr}	-	210	-	ns	V _R =400V, I _F =2.3A, di _F /d <i>t</i> =50A/μs
Reverse recovery charge	Qrr	-	1	-	μC	V _R =400V, I _F =2.3A, di _F /dt=50A/μs
Peak reverse recovery current	I _{rrm}	-	10	-	Α	V _R =400V, I _F =2.3A, di _F /d <i>t</i> =50A/μs

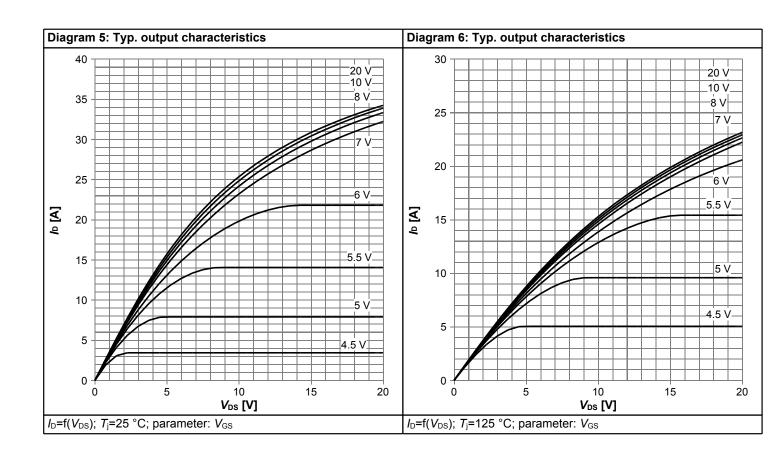


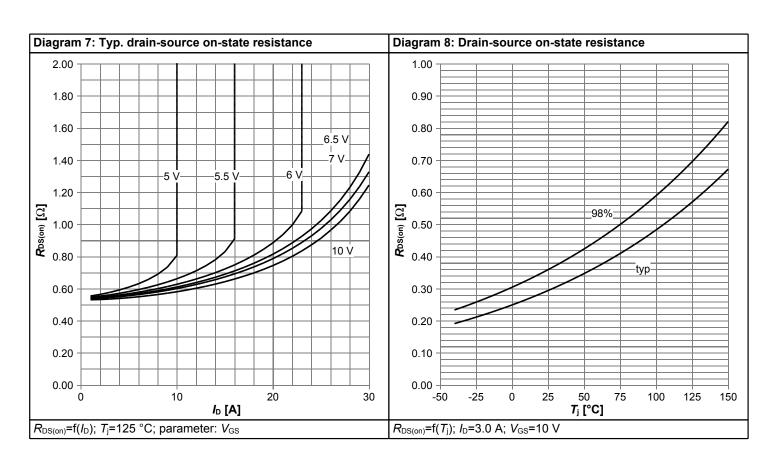
4 Electrical characteristics diagrams



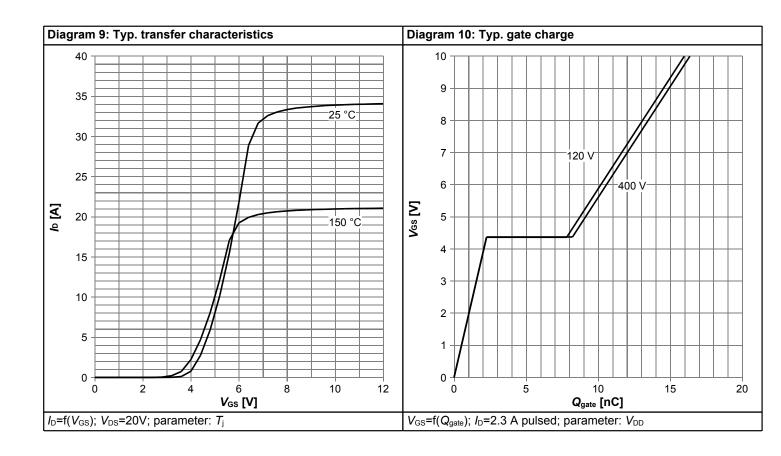


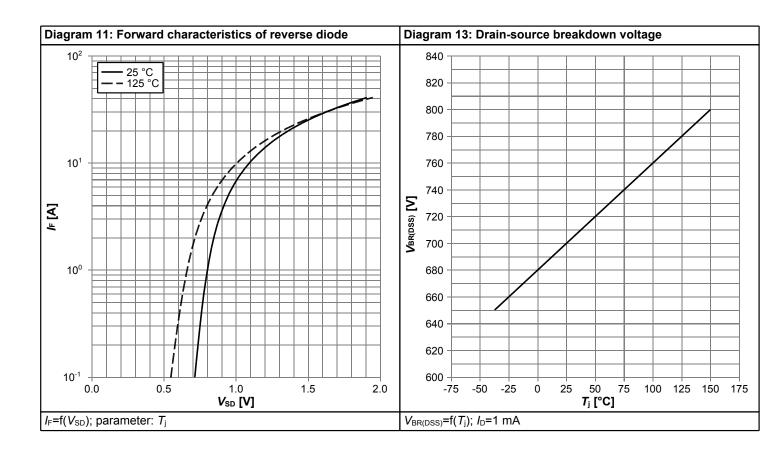




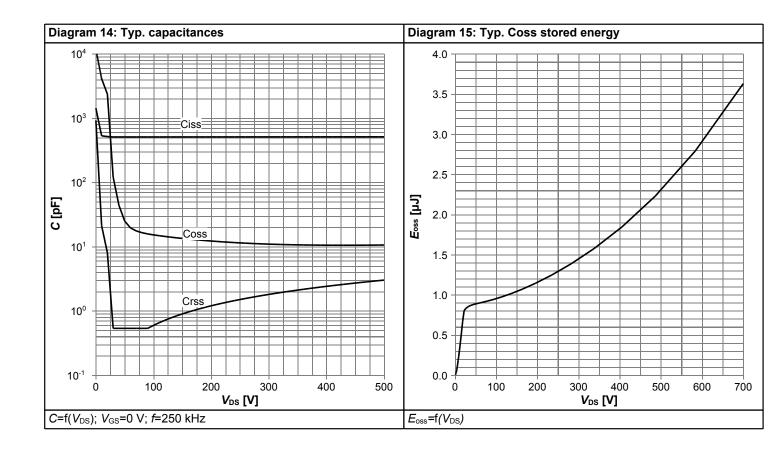














5 Test Circuits

Table 8 Diode characteristics

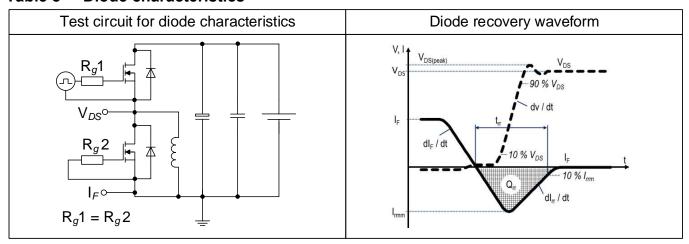
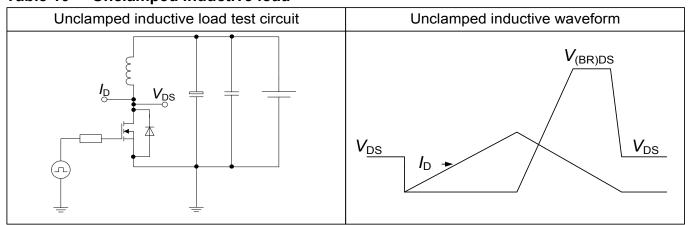


Table 9 Switching times



Table 10 Unclamped inductive load





6 Package Outlines

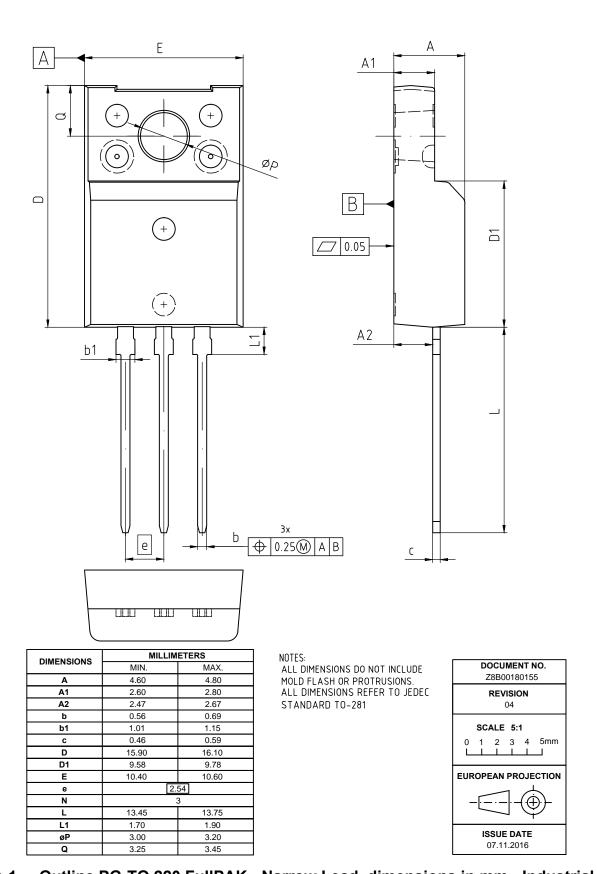


Figure 1 Outline PG-TO 220 FullPAK - Narrow Lead, dimensions in mm - Industrial Grade



7 Appendix A

Table 11 Related Links

• IFX CoolMOS™ P7 Webpage: www.infineon.com

• IFX Design tools: www.infineon.com



Revision History

IPAN70R360P7S

Revision: 2018-02-13, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2017-02-15	Release of final version
2.1	2018-02-13	Corrected front page text

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